

# FORTRON® 0203

## Polyphenylene sulfide

A very easy flowing unfilled grade. This grade demonstrates excellent chemical resistance and thermal stability. Intended for extrusion applications that do not require high melt strength and for compounding with various fillers. Available as Fortron 0203B6 (granular powder), and 0203P6 (pellets)

### Product information

Resin Identification	PPS	ISO 1043
Part Marking Code	>PPS<	ISO 11469

### Typical mechanical properties

Tensile modulus	4200 MPa	ISO 527-1/-2
Tensile stress at break, 5mm/min	33 MPa	ISO 527-1/-2
Tensile strain at break, 5mm/min	1 %	ISO 527-1/-2
Flexural modulus	3900 MPa	ISO 178
Flexural strength	140 MPa	ISO 178
Compressive modulus	4100 MPa	ISO 604
Izod notched impact strength, 23°C	2 kJ/m <sup>2</sup>	ISO 180/1A
Izod impact strength, 23°C	8 kJ/m <sup>2</sup>	ISO 180/1U
Hardness, Rockwell, M-scale	100	ISO 2039-2
Poisson's ratio	0.36 <sup>[C]</sup>	

[C]: Calculated

### Thermal properties

Melting temperature, 10°C/min	280 °C	ISO 11357-1/-3
Glass transition temperature, 10°C/min	90 °C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	120 °C	ISO 75-1/-2
Temperature of deflection under load, 8 MPa	95 °C	ISO 75-1/-2
Coefficient of linear thermal expansion (CLTE), parallel	55 E-6/K	ISO 11359-1/-2
Coefficient of linear thermal expansion (CLTE), normal	53 E-6/K	ISO 11359-1/-2
Specific heat capacity of melt	1830 J/(kg K)	ISO 22007-4

### Electrical properties

Relative permittivity, 1MHz	4	IEC 62631-2-1
Dissipation factor, 1MHz	84 E-4	IEC 62631-2-1
Volume resistivity	1E9 Ohm.m	IEC 62631-3-1
Electric strength	17 kV/mm	IEC 60243-1
Comparative tracking index	100	IEC 60112
Arc Resistance	124 s	UL 746B

### Physical/Other properties

Water absorption, 2mm	0.02 %	Sim. to ISO 62
Water absorption, Immersion 24h	0.01 %	Sim. to ISO 62
Density	1400 kg/m <sup>3</sup>	ISO 1183

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### Injection

Drying Recommended	yes
Drying Temperature	110 °C
Drying Time, Dehumidified Dryer	2 - 4 h
Processing Moisture Content	≤0.02 %
Melt Temperature Optimum	315 °C
Min. melt temperature	275 °C
Max. melt temperature	320 °C
Screw tangential speed	0.2 - 0.3 m/s
Mold Temperature Optimum	150 °C
Min. mould temperature	135 °C
Max. mould temperature	160 °C
Hold pressure range	30 - 70 MPa
Back pressure	3 MPa
Ejection temperature	230 °C

### Additional information

#### Processing Notes

#### Pre-Drying

FORTRON should in principle be predried. Because of the necessary low maximum residual moisture content the use of dry air dryers is recommended. The dew point should be =< - 30° C. The time between drying and processing should be as short as possible.

#### Storage

For subsequent storage the material should be stored dry in the dryer until processed (<= 60 h).